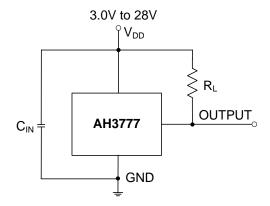


Typical Applications Circuit



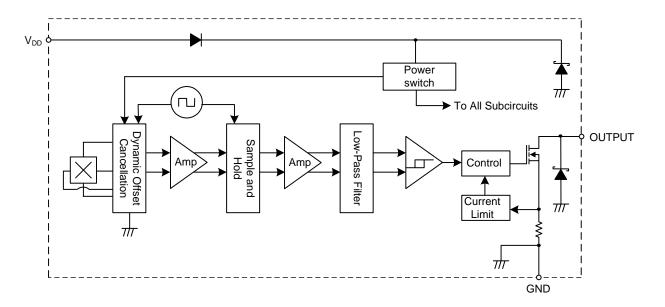
Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF ~ 100nF. R_L is the pull-up resistor.

Pin Descriptions

Package: SOT23 and SIP-3

Pin Number	Pin Name	Function				
1	V_{DD}	Power Supply Input				
2	GND	Ground				
3	OUTPUT	Output Pin				

Functional Block Diagram





Absolute Maximum Ratings (Notes 5 & 6) (@T_A = +25°C, unless otherwise specified.)

Symbol	Characteristic		Value	Unit	
V_{DD}	Supply Voltage (Note 6)		32	V	
V_{DDR}	Reverse Supply Voltage		-32	V	
V_{OUT_MAX}	Output Off Voltage (Note 6)		32V	V	
I _{OUT}	Continuous Output Current		60	mA	
I _{OUT_R}	Reverse Output Current	-50	mA		
В	Magnetic Flux Density		Unlimited		
P _D	Package Power Dissipation	SIP-3	550	mW	
PD	Package Power Dissipation	SOT23	230	mW	
Ts	Storage Temperature Range	-65 to +165	°C		
T_J	Maximum Junction Temperature	+150	°C		
ESD	Electrostatic Discharge Withstand Capability - Human Body Me	odel	6	kV	

Notes:

- 5. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
- 6. The absolute maximum V_{DD} of 32V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

Recommended Operating Conditions (@TA = -40°C to +125°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V_{DD}	Supply Voltage	Operating	3.0 to 28	V
T _A	Operating Temperature Range	Operating	-40 to +125	°C

Electrical Characteristics (Notes 7 & 8) (@T_A = -40°C to +125°C, V_{DD} = 3V to 28V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OUT_ON}	Output On Voltage	$I_{OUT} = 20$ mA, B > Bop	ı	0.2	0.4	V
I _{OUT_OFF}	Output Leakage Current	V _{OUT} = 28V, B < Brp, Output off	-	< 0.1	10	μΑ
I _{DD}	Supply Current	Output open, T _A = 25°C	ı	3	3.5	mA
		Output open, T _A = -40°C to +125°C	ı	-	4	mA
I _{DD R}	Reverse Battery Current	$V_{DD} = -18V$, $T_A = -40$ °C to $+125$ °C	-	-0.01	1	mA
IDD_K	Reverse Battery Ourient	$V_{DD} = -28V$, $T_A = -40^{\circ}C$ to $+125^{\circ}C$	-	-0.01	1.5	mA
t _{ST}	Device Start-Up Time	V _{DD} >= 3V, B > Bop (Note 7)	-	10		μs
f _c	Chopping Frequency	$V_{DD} = 3V$ to 28V	-	800	-	kHz
t _d	The time delay from magnetic threshold reached to the start of the output rise or fall	(Note 9)	-	3.75	-	μs
t _r	Output Rising Time (external pull-up resistor R∟ and load capacitance dependent)	$R_L = 1k\Omega$, $C_L = 20pF$	-	0.2	1	μs
t _f	Output Falling Time (Internal switch resistance and load capacitance dependent)	$R_L = 1k\Omega$, $C_L = 20pF$	ı	0.1	1	μs
I _{OCL}	Output Current Limit	B>Bop, (Note 10)	30	-	55	mA
V_Z	Zener Clamp Voltage	$I_{DD} = 5mA$	28	-		V

- 7. When power is initially turned on, Vob must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.
- anter the start-up time of Tops typical more operating voltage reading 3v.

 8. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.

 9. Guaranteed by design, process control and characterization, Not tested in production.

 10. The device will limit the output current I_{OUT} to current limit of I_{OCL}.

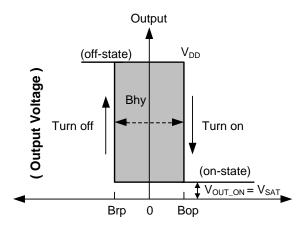


$\textbf{Magnetic Characteristics} \text{ (Notes 11 \&12) (T}_{A} = -40^{\circ}\text{C to } +125^{\circ}\text{C}, \text{ V}_{DD} = 3.0\text{V to 28V, unless otherwise specified)}$

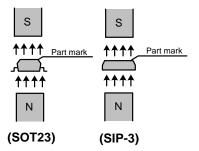
				(1mT=10 G	Bauss)
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P (South pole to part marking side)	Operation Point	V _{DD} = 12V, T _A = +25°C	i	140	i	
B _{op} (South pole to part marking side)	Operation Foliti	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$	110	140	170	
D. (North note to nort marking side)	Release Point	V _{DD} = 12V, T _A = +25°C	ı	-140	ı	Gauss
B _{rp} (North pole to part marking side)	Release Point	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$	-170	-140	-110	
D (ID ID I)	Lhystoresia (Note 12)	$V_{DD} = 12V, T_A = +25^{\circ}C$	-	280	-	
B_{hy} ($ B_{opx} $ - $ B_{rpx} $)	Hysteresis (Note 13)	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$	220	280	340	

Notes:

- 11. When power is initially turned on, V_{DD} must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10us typical from the operating voltage reaching 3V.
 12. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production
- but guaranteed by design, process control and characterization.
- 13. Maximum and minimum hysteresis is guaranteed by design, process control and characterization.



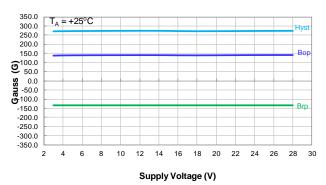
(Magnetic Flux Density B)



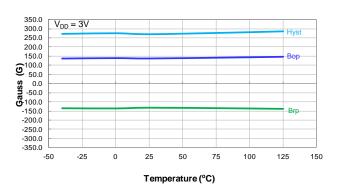


Typical Operating Characteristics

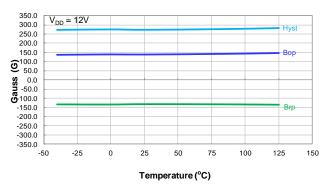
Magnetic Operating Switch Points - Bop and Brp



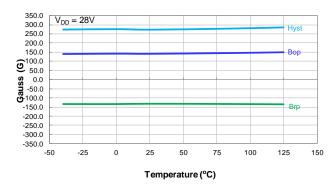
Switch Points Bop and Brp vs Supply Voltage



Switch Points Bop and Brp vs Temperature

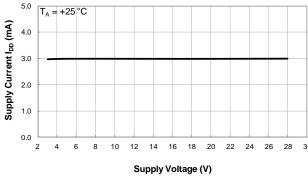


Switch Points Bop and Brp vs Temperature

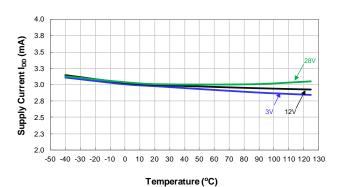


Switch Points Bop and Brp vs Temperature

Supply Current



Supply Current vs Supply Voltage

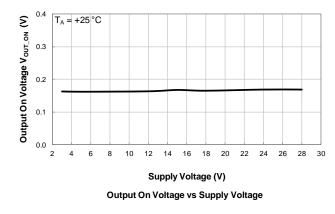


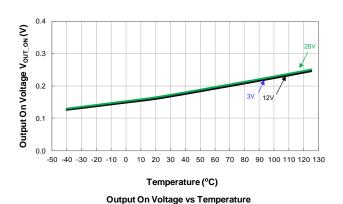
Supply Current vs Temperature



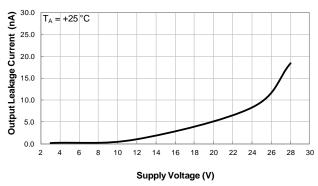
Typical Operating Characteristics

Output Switch On Voltage

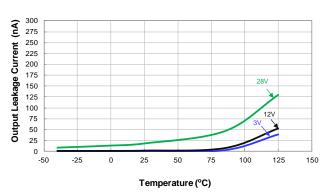




Output Switch Leakage Current

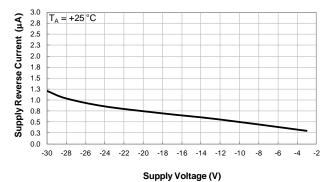


Output Leakage Current vs Supply Voltage

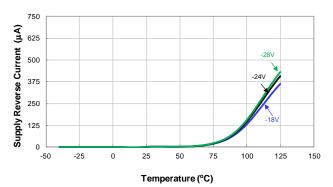


Output Leakage Current vs Temperature

Supply Reverse Current



Supply Reverse Current vs Supply Voltage



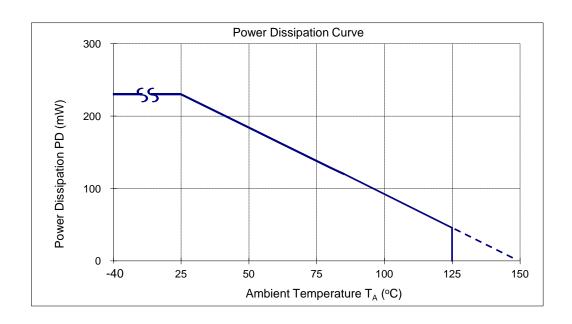
Supply Reverse Current vs Temperature



Thermal Performance Characteristics

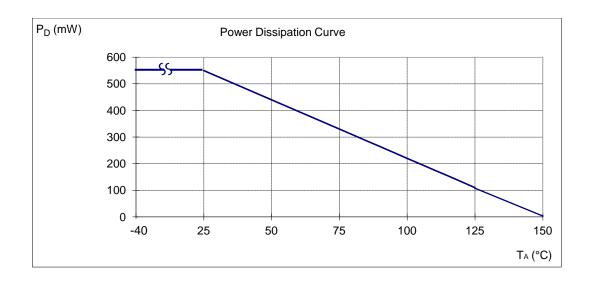
(1) Package type: SOT23

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	83	74	55	46	37	18	0



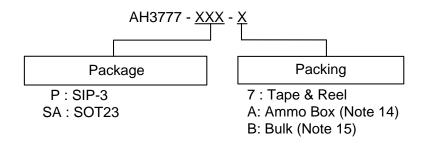
(2) Package type: SIP-3

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	550	440	396	362	308	286	264	220	198	176	132	110	88	44	0





Ordering Information



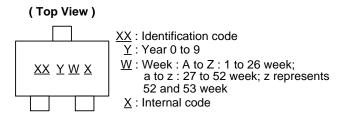
	Package Packaging Bulk 7" Tape		7" Tape an	d Reel	Amm	по Вох		
Part Number	Package Code	rackaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3777-P-A	Р	SIP-3	NA	NA	NA	NA	4,000/Box	-A
AH3777-P-B	Р	SIP-3	1,000	-B	NA	NA	NA	NA
AH3777-SA-7	SA	SOT23	NA	NA	3,000/Tape & Reel	-7	NA	NA

Notes:

- 14. Ammo Box is for SIP-3 Spread Lead.
- 15. Bulk is for SIP-3 Straight Lead.

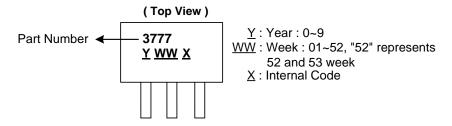
Marking Information

(1) Package Type: SOT23



Part Number	Package	Identification Code		
AH3777	SOT23	ZG		

(2) Package Type: SIP-3



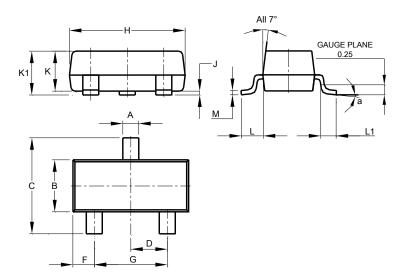
Part Number	Package	Identification Code		
AH3777	SIP-3	3777		



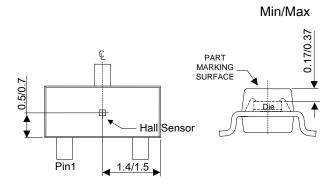
Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(1) Package Type: SOT23



	SO	T23				
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
M	0.085	0.150	0.110			
а	a 8°					
All	Dimens	ions in	mm			



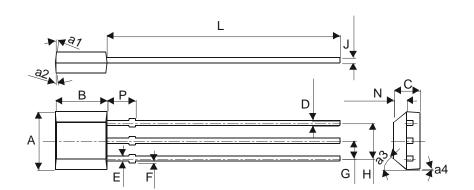
Sensor Location



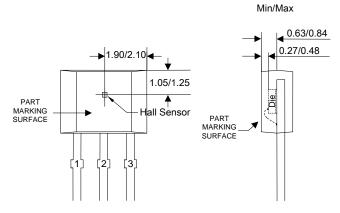
Package Outline Dimensions (cont.) (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(2) Package Type: SIP-3 Bulk



;	SIP-3 (Bu	lk)
Dim	Min	Max
Α	3.9	4.3
a1	5°	Тур
a2	5°	Тур
а3	45°	[°] Typ
a4	3°	Тур
В	2.8	3.2
С	1.40	1.60
D	0.33	0.432
Е	0.40	0.508
F	0	0.2
G	1.24	1.30
Н	2.51	2.57
J	0.35	0.43
L	14.0	15.0
N	0.63	0.84
Р	1.55	=
All Di	mension	s in mm



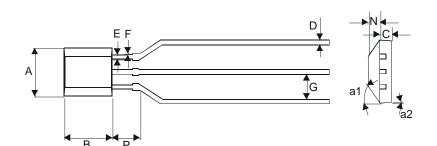
Sensor Location



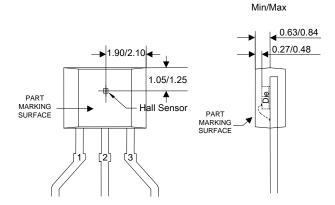
Package Outline Dimensions (cont.) (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(3) Package Type: SIP-3 Ammo Pack



SIP-3 (Ammo Pack)		
Dim	Min	Max
Α	3.9	4.3
a1	45° Typ	
a2	3° Typ	
В	2.8	3.2
C	1.40	1.60
D	0.35	0.41
Е	0.43	0.48
F	0	0.2
G	2.4	2.9
N	0.63	0.84
Р	1.55	-
All Dimensions in mm		



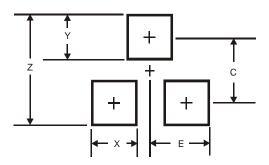
Sensor Location



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

(1) Package Type: SOT23



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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